**ELECTRONIC PACKAGING (Z112)**

Graduate Certificate Program  
College: Engineering

**Abstract**

The Graduate Certificate in Engineering program is designed to assist engineers and technical professionals in the development of their careers and to provide the expertise needed in the rapidly changing business, government, and industrial environments.

Our electronic packaging Graduate Certificate in Engineering leverages the university’s unique strength in reliability along with its expertise in electrical engineering, mechanical engineering, materials science, and business to empower students to further careers in areas such as avionics, automotive electronics, industrial motor drives, military electronics, and medical equipment. Course topics include basics of electronic system integration, heat transfer, thermal management, stress analysis, cost analysis, quality and reliability assessment, and prognostics and health management.

**Financial Assistance**

Students in this program pay a special tuition rate, which does not differ between residents and non-residents of Maryland. This rate is not fully covered by graduate assistantships, fellowships or the tuition remission. Additional graduate student fees are charged. Tuition and fees are subject to change.

This program does not provide departmental assistantships or fellowships. Loans, work-study and need-based grants for citizens and permanent residents with demonstrated financial need may submit a Free Application for Federal Student Aid (FAFSA) by appropriate FAFSA deadlines. For more information on this process, visit: https://fafsa.ed.gov/deadlines.htm.

**Contact**

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**Website:** https://mage.umd.edu/

**Courses:** ENRE (https://umd-curr.courseleaf.com/graduate/courses/enre/)  
ENME (https://umd-curr.courseleaf.com/graduate/courses/enme/)

**Admissions**

**General Requirements**

- Statement of Purpose (https://advancedengineering.umd.edu/application-process/)
- Transcript(s)

- TOEFL/IELTS/PTE (international graduate students (https://gradschool.umd.edu/admissions/english-language-proficiency-requirements/))

**Program-Specific Requirements**

- Letters of Recommendation (optional): Two (2) Letters of Recommendation are required for anyone with an undergraduate GPA below 3.0. Anyone with a GPA 3.0 or above should contact the MAGE with a request to waive this requirement.
- Graduate Record Examination (GRE) (optional)
- CV/Resume (optional)

For additional program-specific admission requirements, please visit: https://mage.umd.edu/electronic-packaging (https://mage.umd.edu/electronic-packaging/).

*Visa Eligibility: This program is not eligible for I-20 or DS-2019 issuance by the University of Maryland.

**APPLICATION DEADLINES**

<table>
<thead>
<tr>
<th>Type of Applicant</th>
<th>Fall Deadline</th>
<th>Spring Deadline</th>
</tr>
</thead>
<tbody>
<tr>
<td>Domestic Applicants</td>
<td></td>
<td></td>
</tr>
<tr>
<td>US Citizens and Permanent Residents</td>
<td>August 1, 2023</td>
<td>December 15, 2022</td>
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<tr>
<td>International Applicants</td>
<td></td>
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<tr>
<td>F (student) or J (exchange visitor)</td>
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<td>N/A</td>
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<tr>
<td>visas; A,E,G,H,I and L visas and immigrants</td>
<td>N/A</td>
<td>N/A</td>
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**RESOURCES AND LINKS:**

**Program Website:** mage.umd.edu (https://mage.umd.edu/)

**Application Process:** gradschool.umd.edu/admissions (https://gradschool.umd.edu/admissions/)

**Requirements**


**Facilities and Special Resources**

This program is currently offered in-person at the College Park Campus. In addition to in-person courses, you may have the option to take some course requirements in an online format. Course format offerings are subject to change.

This program is also offered 100% online. Please see Electronic Packaging (Z111) for more information.